Examine's 6 ps

AN 129:305269 HCA TI Tin solder alloys

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PA

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DT Patent

LΑ German

FAN. CNT 2

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		PATENT NO.	KIND DATE	APPLICATION NO.	DATE
	PΙ	DE 19816671	A1 199810	DE 1998-19816671	19980415
		JP 10286689	A2 199810	JP 1997-97828	19970416
		JP 11058066	A2 199903	02 JP 1997-212969	19970807
		JP 11077366	A2 199903	23 JP 1998-169937	19980617
	PRAI	JP 1997-97828	19970416		
		JP 1997-191391	19970716		
		JP 1997-212969	19970807		

The alloys contain >0-3.5 Sb, .ltoreq.3.0% Ag, and 1st and 2nd AB additives for improving the soldering properties. The 1st additives comprise Cu > 0-1.0 and Ni > 0-1.0%, and the 2nd additives comprise P > 0-1.0 and Ge > 0-1.0%. The alloys contain Ag>0-4.0, Cu >0-2.0, Ni >0-1.0, and P >0-1.0 and/or Ge >0-1.0%.